



PERFORMANCE CHARACTERISTICS:

*MIN.PRESS-FIT RETENTION FORCE: 20N

*MAX CURRENT: 40 A

*ALLOWED PCB THICKNESS: MIN. 1,6 mm.

RECOMMENDED PLATED THROUGH HOLE:

*DRILLED HOLE : Ø 3.19 - 3.25 mm.

*FINISHED HOLE : Ø 3.02 - 3.20 mm.

*Cu PLATING : 25 um MIN.

*Sn/SnPb PLATING : 5 um MIN.

NOTE:

1, TO BE USED ONLY WITH TYPE L,M UN SHIELDED & TYPE N CONNECTOR.

2, FOR MISSING INFO SEE DRAWING BS,C ,201624,028

LEAD FREE INDICATOR : LF = LEAD FREE -PLATING CODE (REF DWG No. BS,C ,201624,028)

4. THIS PRODUCT (LF) MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008

					Mate	rial				Spec ref	/			
				Mat code						tolerance 1DEC ± 0.2 1DEC 2DEC ± 0.1 2DEC	projection	ММ		
				Heattreat					\ /		⊕ □	_ * *		
					Plating/Finish						ANGLES ± 1* HOEKEN			
	_				Dr	M.FR	ET	26-06-97				size	Scale	
r	.e.		dr	date	Eng Produ				Produc	t family	MILLIPACS	3.20 A4	1/1	
P	١	CONVERSION REVISION 04	KN	14-09-01	Chr				Model			ECN		
E		EC B20050	MF	18-03-02	Appr					Revision		REL Level		
C	:	ADDING NOTE EC B20137	BVE	25/07/02				I HOGEL K		Revision		KEL Level		
Ι			ALEX B	04-06-05	FG)			FEMALE E	YF D/T	NEEDLE	۵,	00400460	4000	Rev.
Е	:	105-0157	ALEX B	06-09-05				PRESS-FIT			6 w p	BSA20162	4020	
F	. [DG07-0411	KASON	17-10-07				INCSS III IUWEN		CUNTACT	οlγ			1
					Pro/	E file	catalog	no	RC12F	PIE70	CUSTOMER	DRAWING	sheet 1 of	1